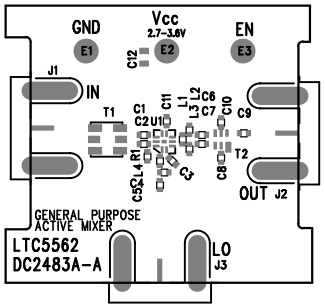
REVISION HISTORY				
ECO	REV	DESCRIPTION	APP. ENG.	DATE
–	3	3 RD PROTO	WESTON S.	04-24-17

NOTES: UNLESS OTHERWISE SPECIFIED

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
2. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD. MAXIMUM SOLDER TEMPERATURE IS 240 DEGREES CELSIUS.
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS. LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. NO SHUNT
5. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
6. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP TO ANY BOARD.
7. INSTALL J1-J3 CONNECTORS AS SHOWN BELOW:



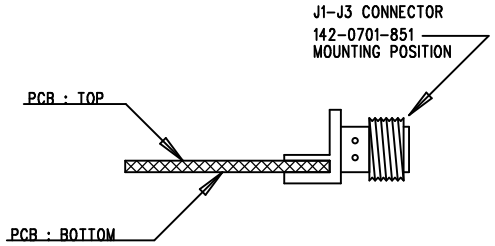
TOP SILKSCREEN

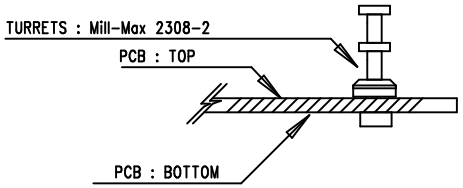
LINEAR TECHNOLOGY

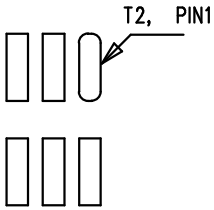
DC2483A-A-3 * LTC5562

DATE: 04-24-2017

GENERAL PURPOSE ACTIVE MIXER







APPROVALS	
PCB DES.	AK
APP ENG.	WESTOM S.
SCALE = NONE	

LINEAR TECHNOLOGY

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TITLE: TOP ASSEMBLY DRAWING

GENERAL PURPOSE ACTIVE MIXER

SIZE	IC NO.	REV.
N/A	LTC5562 DEMO CIRCUIT 2483A-A	3

FILENAME: DC2483A-A-3.PCB